Electrical properties of large single-crystal tungsten disulfide grown by liquid precursor chemical vapor deposition

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The research in two-dimensional (2D) materials has attracted great interest in recent years, for electronic, spintronic and optoelectronics applications. One class of 2D materials of particular interest are transition metal dichalcogenides (TMDs), where one layer of transition metal atoms is packed between two layers of dichalcogenide atoms[1]. One of the most interesting properties of this class of material is the presence of a bandgap, which changes from indirect to direct when the thickness goes from bulk to monolayer[2].

One of the most promising TMDs is tungsten disulfide $(WS_2)[3]$, due to the presence of a direct bandgap in the visible range (around 2 eV) that makes it suitable for electronics and optoelectronics applications. Hence, controlling the growth process in order to obtain highly crystalline WS_2 with appreciable electronic and optical properties is of primary importance.

Here we report on the growth, through liquid-phase chemical vapor deposition (LiP-CVD)[4], of monolayer single-crystal WS_2 on Silicon dioxide, with lateral size up to hundreds of micrometers.

The quality of the grown material is assessed through atomic force microscopy (AFM), Raman and photoluminescence spectroscopy, which confirm the single-crystal and monolayer nature of our samples. The electrical properties of LiP-CVD WS₂ are tested with transport measurements. To this end, Transfer Length Measurement (TLM) devices are defined via electron beam lithography (EBL), thermal metal evaporation and reactive ion etching (RIE). We demonstrate field-effect mobilities above 15 cm²/Vs and an on/off ratio in the range of 10⁶. Moreover, we also test the electrical photo-responsivity of the material, proving a wavelength-dependent photocurrent of hundreds of microampere and a photoresponsivity as high as 10 A/W.

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References

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Figure 1: Raman characterization of a LiP-CVD grown WS_2 crystal: On the left, the map of the FWHM(E_{2g}) peak shows homogeneity of the strain on the sample and the high quality of the synthesized material. On the right, the map of the FWHM(A_{1g}) peak demonstrates high level of homogeneity of the sample. Raman characterization has been performed with laser excitation of 473 nm, 1.4 mW of power, the measurements were performed with a 100x (0.89 NA) magnification lens, that produces a spot size of 0,7 μ m.



Figure 2: Electrical characterization of the WS₂-based FET device: On the left, the output characteristic of a device demonstrates current in the order of tens of μ A; the super-linear onset for applied biases below 0.5 V suggests the presence of a contact-limited transport. On the right, a transfer curve in a semi-log scale, WS₂ FET device show a n-type behavior, with an on/off ratio above 10⁵ and onset voltage around 20 V (over 285 nm of SiO₂); we obtained FET mobility of 15 cm²/Vs.